Special Issue

Machine Learning Applications in Image and Signal Processing: Challenges and Solutions

Message from the Guest Editor

The integration of machine learning (ML) with image and signal processing has revolutionized various fields by enhancing researchers' ability to analyse and interpret complex data. ML algorithms can extract meaningful features from signals and images, improve classification accuracy, and enable advanced functionalities such as real-time processing and automated decision-making. This synergy between ML and image/signal processing has broad applications, including medical diagnostics, remote sensing, security, and multimedia. This Special Issue highlights innovative research and addresses ongoing challenges in this field, with a particular focus on signal and image processing, signal reconstruction, image quantization, and advanced medical imaging applications. It serves as a platform for researchers to share their cutting-edge research, insights, and experiences, fostering collaboration and advancing the field. This Special Issue's scope includes a wide range of topics related to the machine learning applications in image and signal processing.

Guest Editor

Dr. Siamak Pedrammehr

1. Faculty of Design, Tabriz Islamic Art University, Tabriz, Iran 2. Institute for Intelligent Systems Research and Innovation, Deakin University, Waurn Ponds, VIC, Australia

Deadline for manuscript submissions

closed (15 April 2025)



an Open Access Journal by MDPI

Impact Factor 2.6 CiteScore 6.1



mdpi.com/si/212262

Electronics Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41 61 683 77 34 electronics@mdpi.com

mdpi.com/journal/

electronics





an Open Access Journal by MDPI

Impact Factor 2.6 CiteScore 6.1



electronics



About the Journal

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

Editor-in-Chief

Prof. Dr. Flavio Canavero Department of Electronics and Telecommunications, Politecnico di Torino, 10129 Torino, Italy

Author Benefits

High Visibility:

indexed within Scopus, SCIE (Web of Science), CAPlus / SciFinder, Inspec, Ei Compendex and other databases.

Journal Rank:

JCR - Q2 (Engineering, Electrical and Electronic) / CiteScore - Q1 (Electrical and Electronic Engineering)

Rapid Publication:

manuscripts are peer-reviewed and a first decision is provided to authors approximately 16.8 days after submission; acceptance to publication is undertaken in 2.4 days (median values for papers published in this journal in the first half of 2025).